



flowPIM 1 + PFC

600 V / 50 A

Features

- Highly integrated PIM with interleaved PFC circuit
- High switching frequency PFC circuit
- On-board capacitors
- New generation high speed IGBTs in the inverter

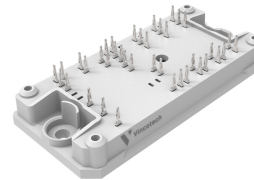
Target applications

- Embedded Drives
- Industrial Drives

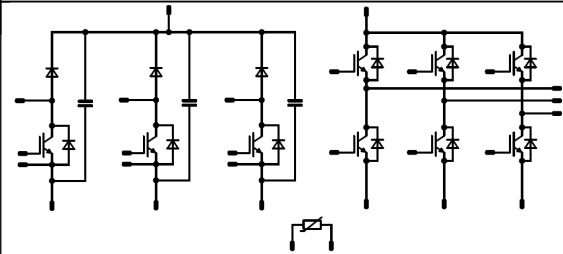
Types

- 10-PG06PPA050SJ02-LH94E08T

flow 1 12 mm housing



Schematic





Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	49	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	81	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 400\text{ V}$ $T_j = 150\text{ °C}$	5	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	36	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	58	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

PFC Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	29	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	68	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
PFC Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	32	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	180	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	59	W
Maximum junction temperature	T_{jmax}		175	°C

PFC Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	18	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	33	W
Maximum junction temperature	T_{jmax}		175	°C

Capacitor (PFC)

Maximum DC voltage	V_{MAX}		630	V
Operation Temperature	T_{op}		-55 ... 150	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			8,05	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0008	25	4,1	5,1	5,7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		50	25 125 150		1,49 1,61 1,64	1,8 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	600		25			2,8	μA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							1950		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		83		pF
Reverse transfer capacitance	C_{res}							67		pF
Gate charge	Q_g	$V_{CC} = 480$ V	15		50	25		249		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,18		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		70 70 71,2		ns
Rise time	t_r					25 125 150		45,2 43,2 42,8		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		114,8 133,6 138,6		ns
Fall time	t_f					25 125 150		22,47 34,2 41,12		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tfwd} = 1,62$ μC $Q_{tfwd} = 3,09$ μC $Q_{tfwd} = 3,57$ μC				25 125 150		1,84 2,2 2,28		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,536 0,839 0,941		mWs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max			

Inverter Diode

Static

Parameter	Symbol	Conditions	V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Forward voltage	V_F				30	25 150	1,25	1,64 1,55	1,95 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 600$ V				25			27	μA

Thermal

Parameter	Symbol	Conditions	V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,63		K/W

Dynamic

Parameter	Symbol	Conditions	V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Peak recovery current	I_{RRM}	$di/dt=245$ A/μs $di/dt=545$ A/μs $di/dt=378$ A/μs	±15	350	50	25		10,63		A
Reverse recovery time	t_{rr}					125		16,09		ns
						150		16,77		
						25		251,47		
Recovered charge	Q_r					125		331,66		μC
						150		392,82		
		25		1,62						
Reverse recovered energy	E_{rec}	125		3,09		mWs				
		150		3,57						
		25		0,406						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	125		0,762		A/μs				
		150		0,892						
		25		76,03						



Vincotech

10-PG06PPA050SJ02-LH94E08T
datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	

PFC Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0003	25	3,3	4	4,7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	25 125		1,97 2,25	2,22 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			40	μA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							2100		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		45		pF
Reverse transfer capacitance	C_{res}							7,7		pF
Gate charge	Q_g	$V_{CC} = 520$ V	15		30	25		65		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,39		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		12 12 13		ns
Rise time	t_r					25 125 150		8 8 8		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		80 94 98		ns
Fall time	t_f					25 125 150		7,96 9,61 10,37		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 0,394$ μC $Q_{tFWD} = 0,956$ μC $Q_{tFWD} = 1,17$ μC				25 125 150		0,391 0,524 0,451		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,086 0,207 0,332		mWs



Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max			

PFC Diode

Static

Parameter	Symbol	Conditions	V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Forward voltage	V_F				30	25 125		2,47 2,03	2,6 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 650$ V				25			10	μA

Thermal

Parameter	Symbol	Conditions	V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,61		K/W

Dynamic

Parameter	Symbol	Conditions	V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Peak recovery current	I_{RRM}	$di/dt=4524$ A/μs $di/dt=4528$ A/μs $di/dt=4350$ A/μs	0/15	400	30	25		24,18		A
Reverse recovery time	t_{rr}					125		39,85		ns
						150		45,05		
						25		18,85		
Recovered charge	Q_r					125		0,394		μC
						150		0,956		
		25		1,17						
Reverse recovered energy	E_{rec}	125		0,088		mWs				
		150		0,221						
		25		0,275						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	125		2361		A/μs				
		150		2958						
		25		3147						



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

PFC Sw. Protection Diode

Static

Forward voltage	V_F				10	25 125	1,23	1,67 1,54	1,87 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 650$ V				25			0,14	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,87		K/W
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Capacitor (PFC)

Static

Capacitance	C	DC bias voltage = 0 V				25		33		nF
Tolerance							-5		5	%

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta R/R$	$R_{100} = 1484$ Ω				100	-5		5	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.

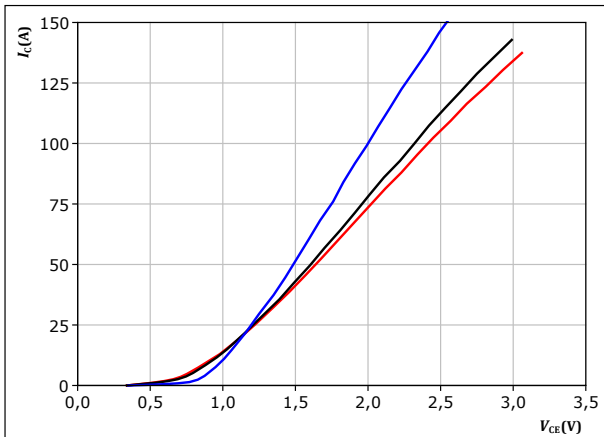


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

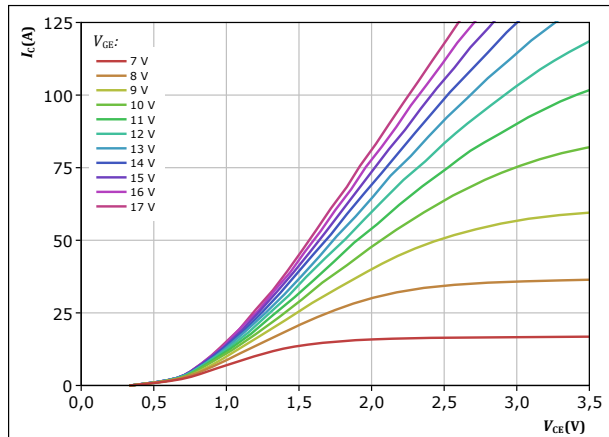


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

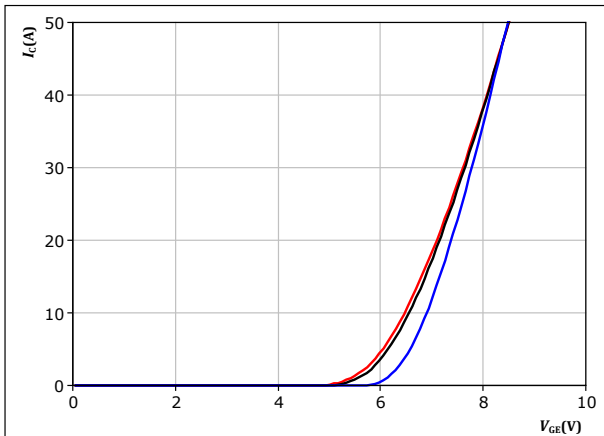


$t_p = 250 \mu s$
 $T_j = 150 \text{ }^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

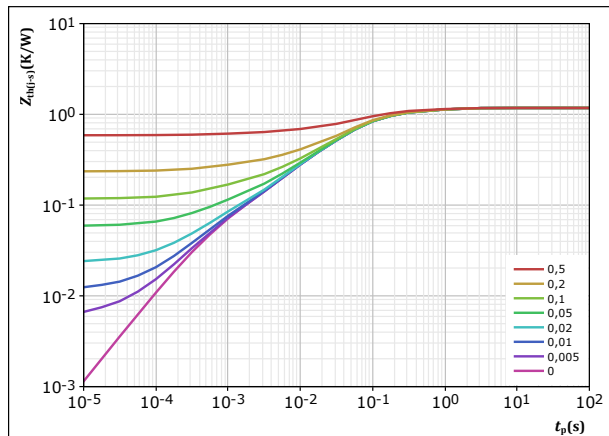


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,176 \text{ K/W}$
IGBT thermal model values

R (K/W)	τ (s)
1,28E-01	9,19E-01
3,00E-01	1,49E-01
5,67E-01	4,76E-02
1,34E-01	6,63E-03
4,70E-02	5,83E-04



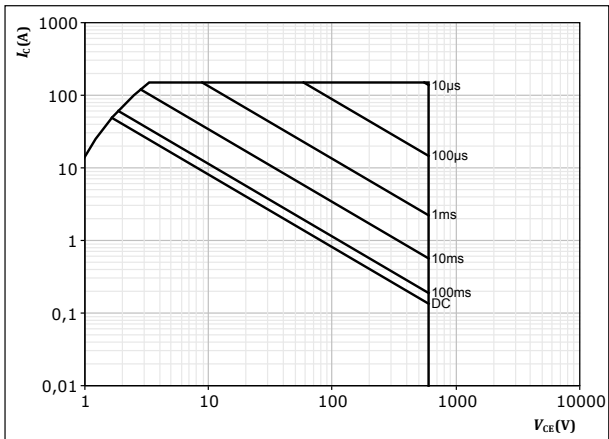
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Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80$ °C

$V_{CE} = 15$ V

$T_j = T_{jmax}$



Inverter Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

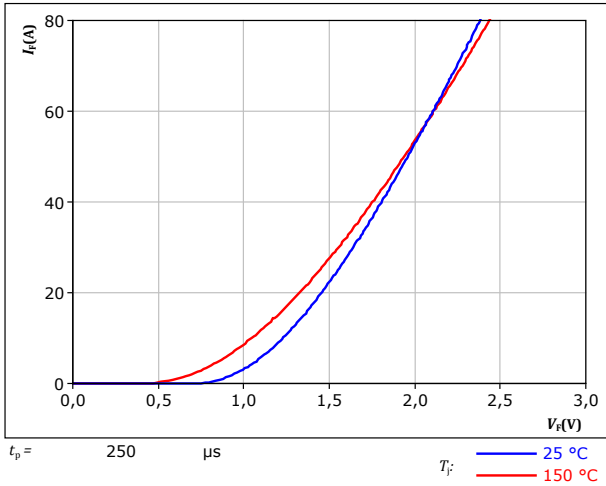
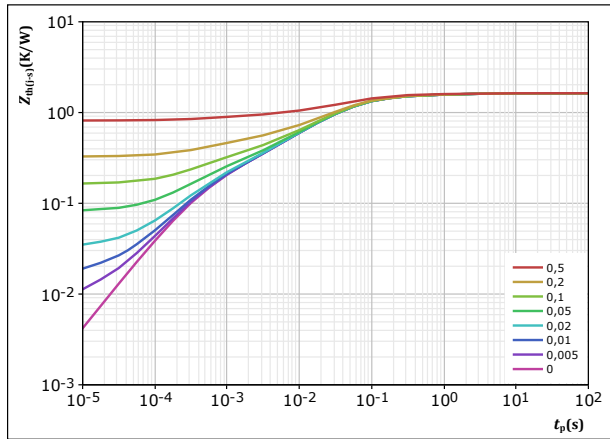


figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,633 \text{ K/W}$
 FWD thermal model values

R (K/W)	τ (s)
7,13E-02	2,70E+00
1,55E-01	3,01E-01
7,25E-01	5,48E-02
3,93E-01	1,54E-02
1,57E-01	2,76E-03
1,32E-01	4,03E-04

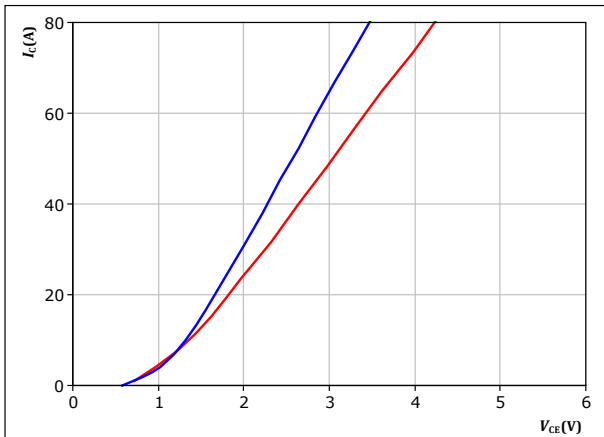


PFC Switch Characteristics

figure 8. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

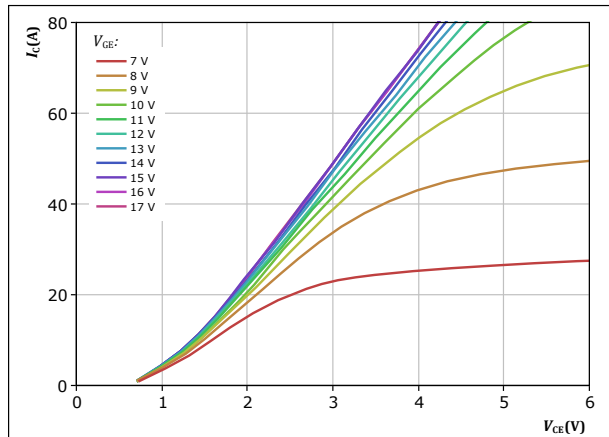


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25^\circ C$ (blue line)
 $125^\circ C$ (red line)

figure 9. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

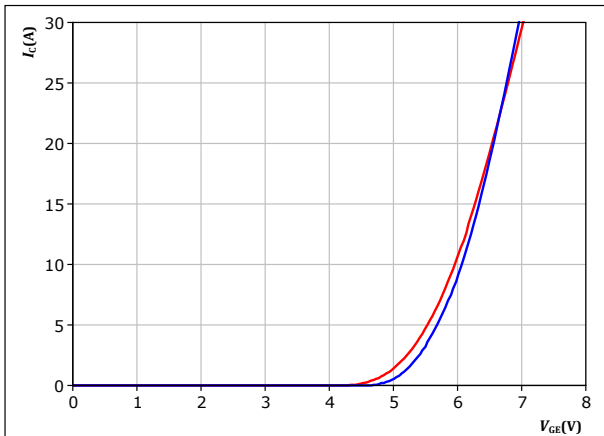


$t_p = 250 \mu s$
 $T_j = 125^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 10. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

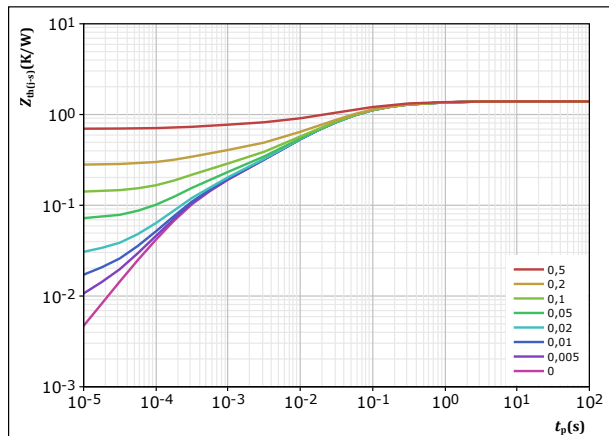


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25^\circ C$ (blue line)
 $125^\circ C$ (red line)

figure 11. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,394 K/W$
IGBT thermal model values

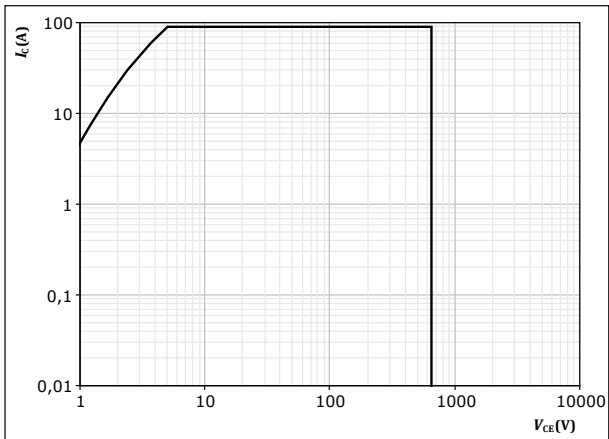
R (K/W)	τ (s)
8,66E-02	1,03E+00
1,95E-01	1,93E-01
5,59E-01	5,17E-02
3,47E-01	9,99E-03
9,37E-02	1,86E-03
1,12E-01	2,95E-04



PFC Switch Characteristics

figure 12. IGBT

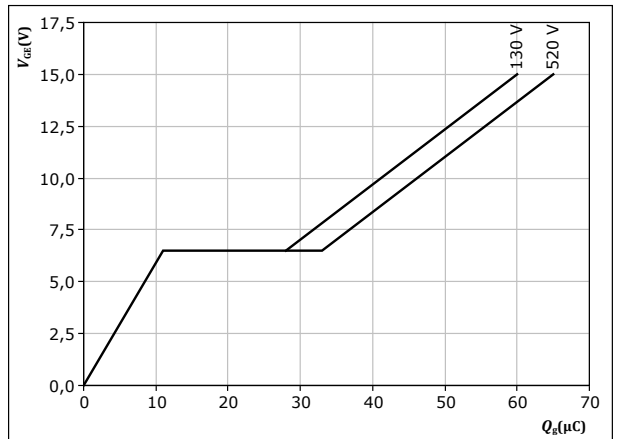
Safe operating area
 $I_C = f(V_{CE})$



$D =$ single pulse
 $T_s = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$

figure 13. IGBT

Gate voltage vs gate charge
 $V_{GE} = f(Q_g)$



$I_C = 30$ A
 $T_j = 25$ °C



PFC Diode Characteristics

figure 14. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

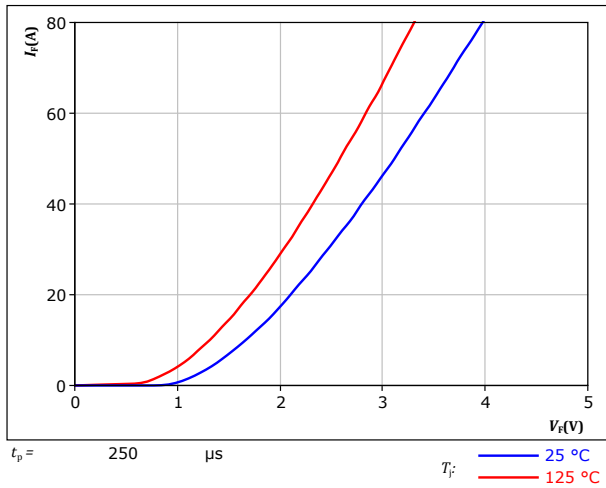
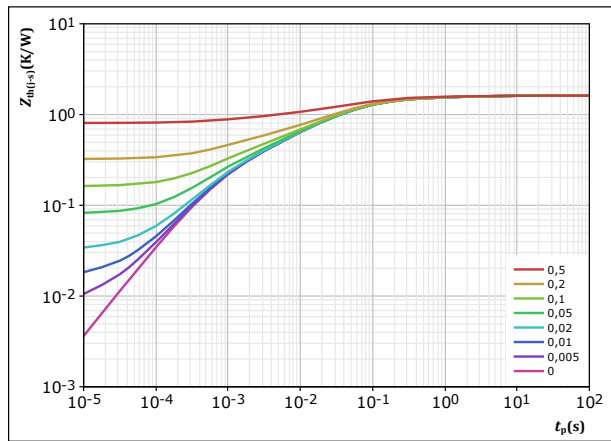


figure 15. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$

$R_{th(j-s)} = 1,615 \text{ K/W}$

FWD thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
6,26E-02	3,75E+00
1,57E-01	4,48E-01
5,80E-01	7,07E-02
4,30E-01	1,76E-02
2,34E-01	3,12E-03
1,51E-01	5,87E-04



PFC Sw. Protection Diode Characteristics

figure 16. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

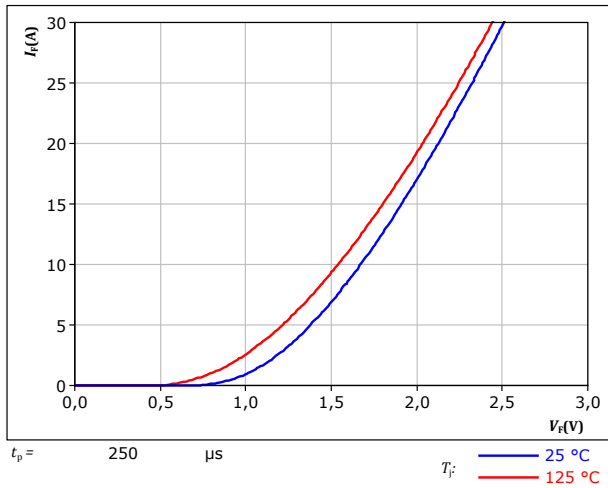
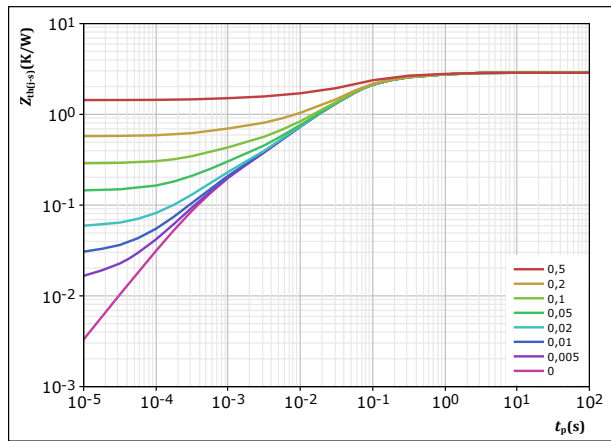


figure 17. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	2,874	K/W
FWD thermal model values		
R (K/W)	τ (s)	
2,86E-01	1,08E+00	
5,75E-01	1,73E-01	
1,57E+00	4,54E-02	
3,05E-01	5,64E-03	
1,34E-01	5,58E-04	

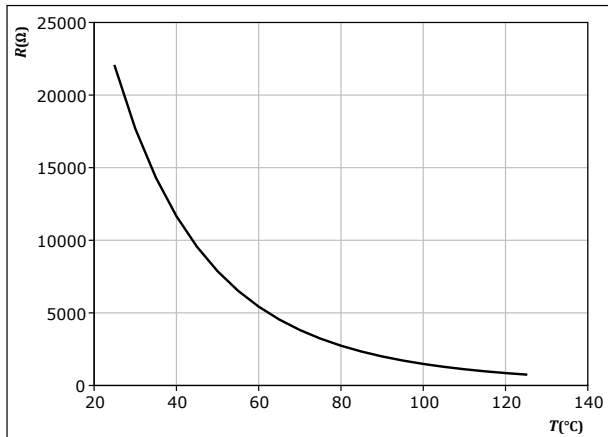


Thermistor Characteristics

figure 18. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

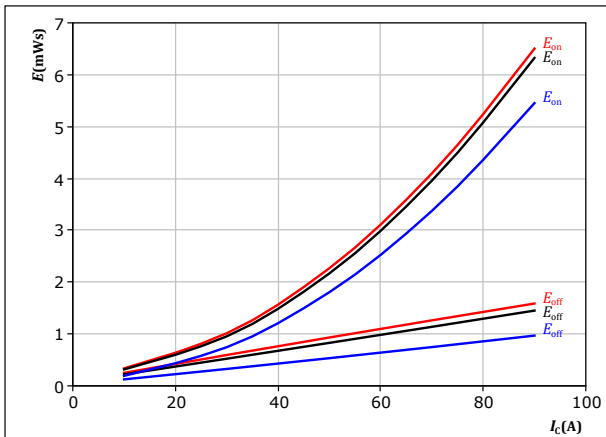




Inverter Switching Characteristics

figure 19. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

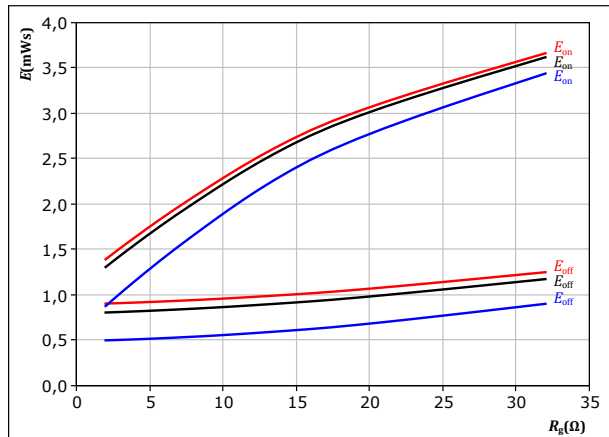


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{g(on)} = 8$ Ω
 $R_{g(off)} = 8$ Ω

T_f : — 25 °C
 — 125 °C
 — 150 °C

figure 20. IGBT

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$

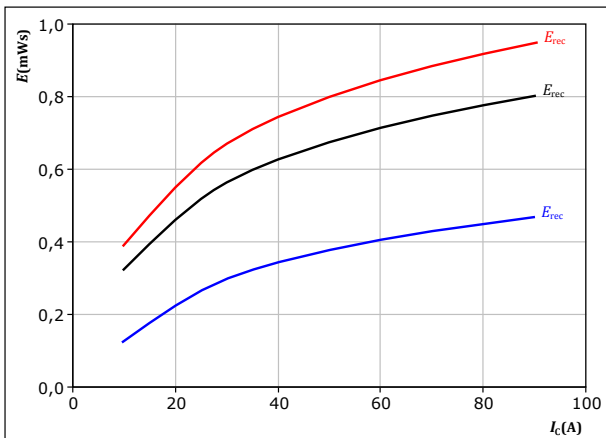


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A

T_f : — 25 °C
 — 125 °C
 — 150 °C

figure 21. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

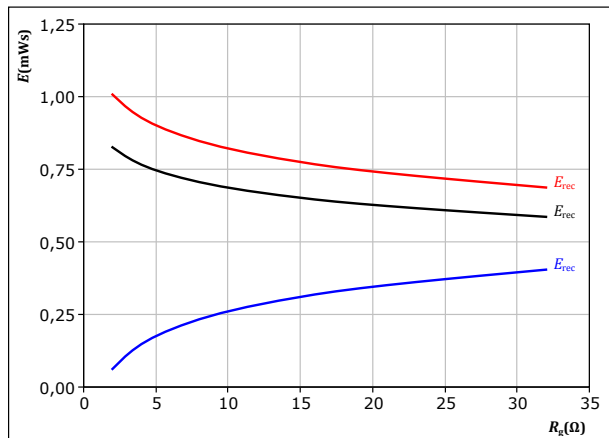


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{g(on)} = 8$ Ω

T_f : — 25 °C
 — 125 °C
 — 150 °C

figure 22. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A

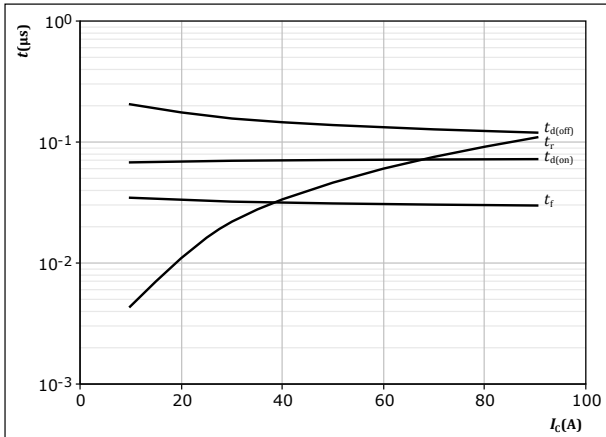
T_f : — 25 °C
 — 125 °C
 — 150 °C



Inverter Switching Characteristics

figure 23. IGBT

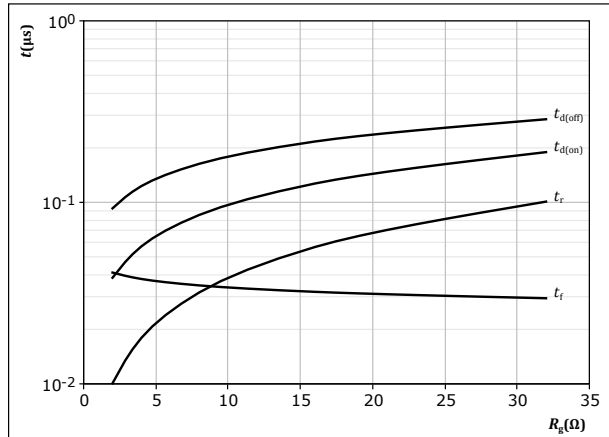
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{g(on)} = 8 \text{ } \Omega$
 $R_{g(off)} = 8 \text{ } \Omega$

figure 24. IGBT

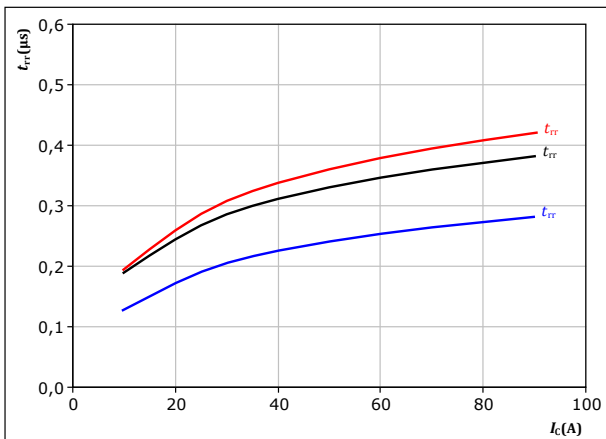
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 50 \text{ A}$

figure 25. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$

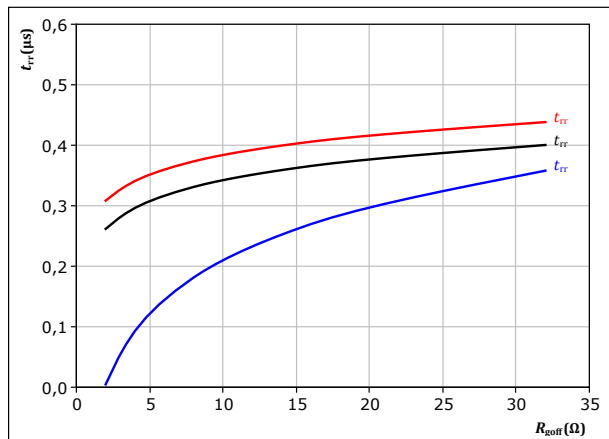


With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{g(on)} = 8 \text{ } \Omega$

T_j :
— 25 $^\circ\text{C}$
— 125 $^\circ\text{C}$
— 150 $^\circ\text{C}$

figure 26. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{g(off)})$



With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 50 \text{ A}$

T_j :
— 25 $^\circ\text{C}$
— 125 $^\circ\text{C}$
— 150 $^\circ\text{C}$

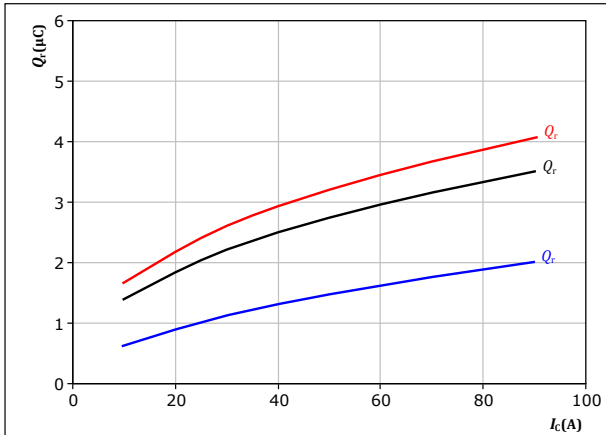


Inverter Switching Characteristics

figure 27. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



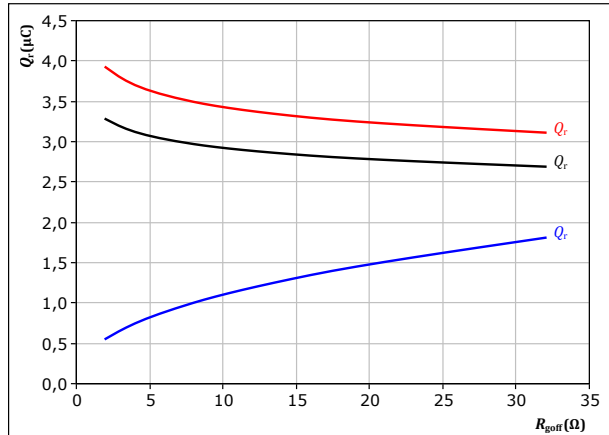
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{goff} = 8$ Ω
 $T_j:$ 25 °C (blue), 125 °C (black), 150 °C (red)

figure 28. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



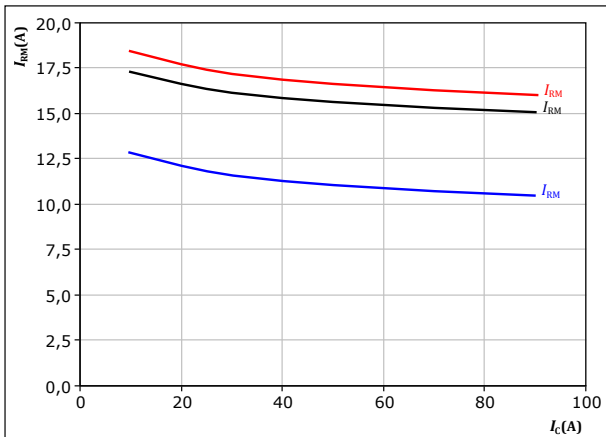
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A
 $T_j:$ 25 °C (blue), 125 °C (black), 150 °C (red)

figure 29. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



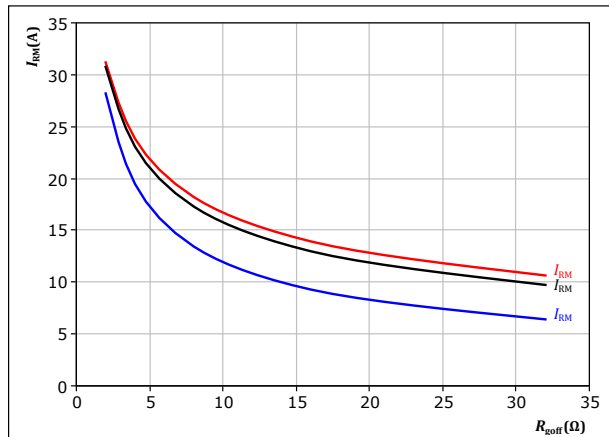
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{goff} = 8$ Ω
 $T_j:$ 25 °C (blue), 125 °C (black), 150 °C (red)

figure 30. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

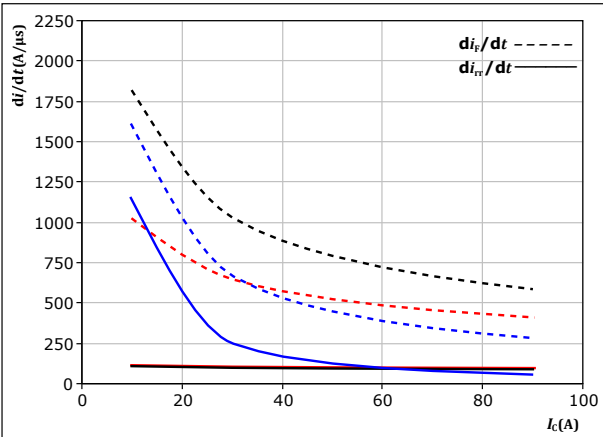
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A
 $T_j:$ 25 °C (blue), 125 °C (black), 150 °C (red)



Inverter Switching Characteristics

figure 31. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$

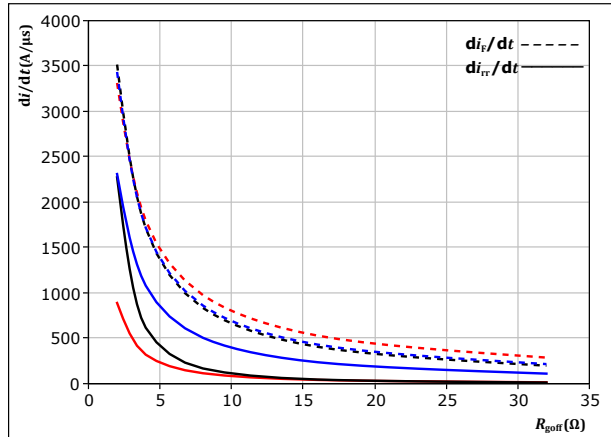


With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{goff} = 8 \text{ } \Omega$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 32. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$

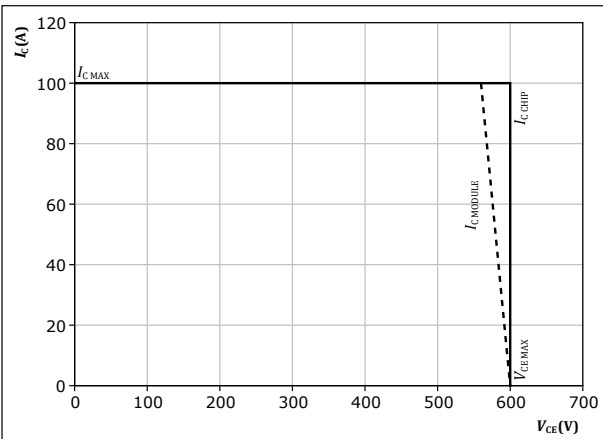


With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 50 \text{ A}$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 33. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$



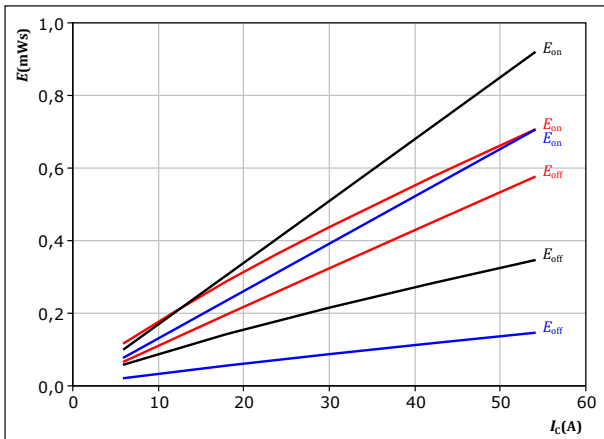
At $T_j = 150 \text{ } ^\circ\text{C}$
 $R_{goff} = 8 \text{ } \Omega$
 $R_{goff} = 8 \text{ } \Omega$



PFC Switching Characteristics

figure 34. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

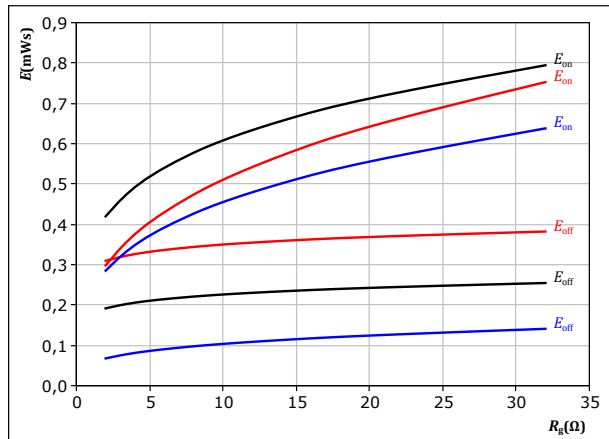


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{g(on)} = 8$ Ω
 $R_{g(off)} = 8$ Ω

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 35. IGBT

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$

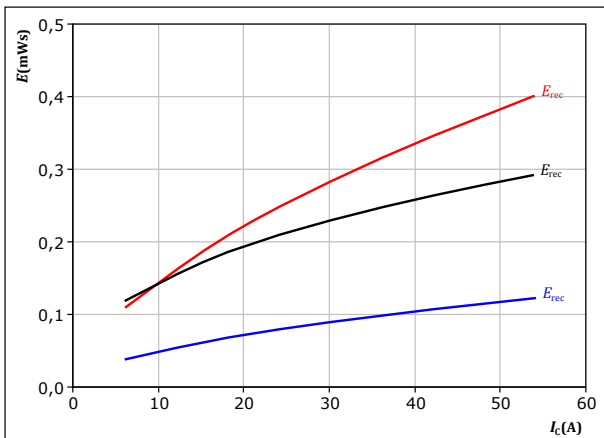


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 30$ A

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 36. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

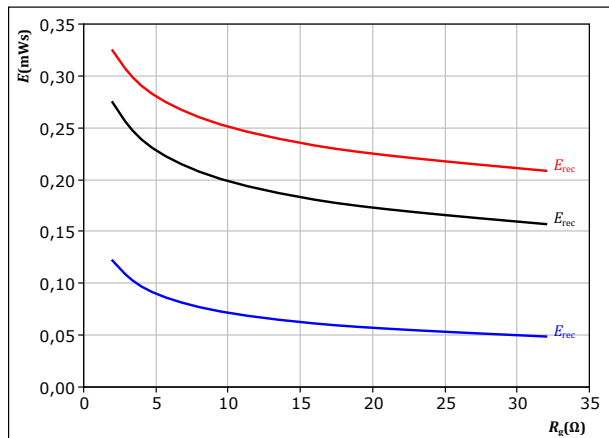


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{g(on)} = 8$ Ω

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 37. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 30$ A

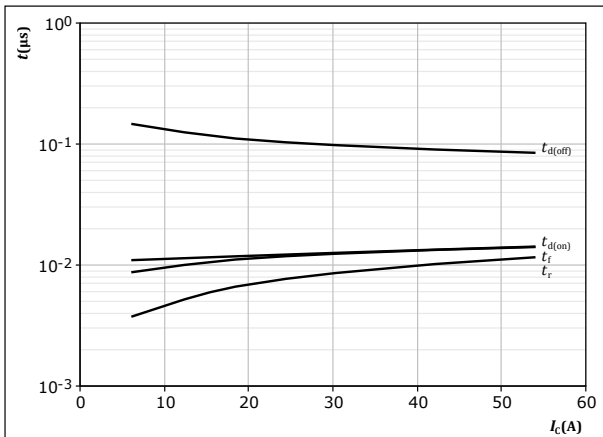
T_j : — 25 °C
 — 125 °C
 — 150 °C



PFC Switching Characteristics

figure 38. IGBT

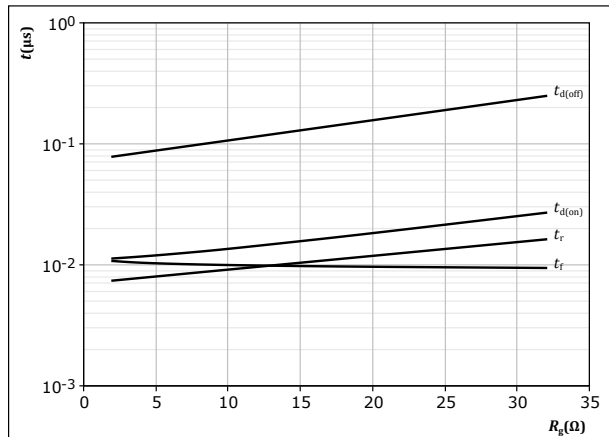
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{g(on)} = 8 \text{ } \Omega$
 $R_{g(off)} = 8 \text{ } \Omega$

figure 39. IGBT

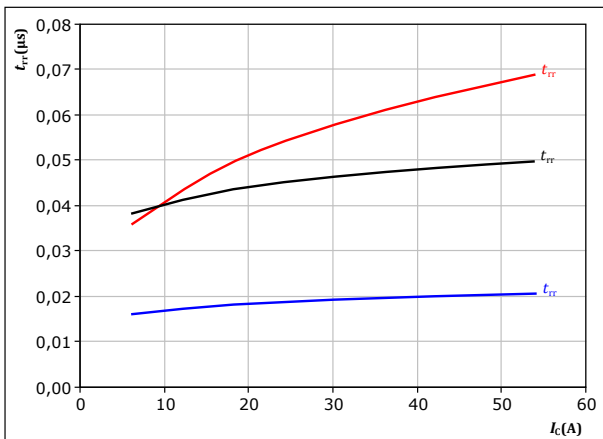
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 30 \text{ A}$

figure 40. FWD

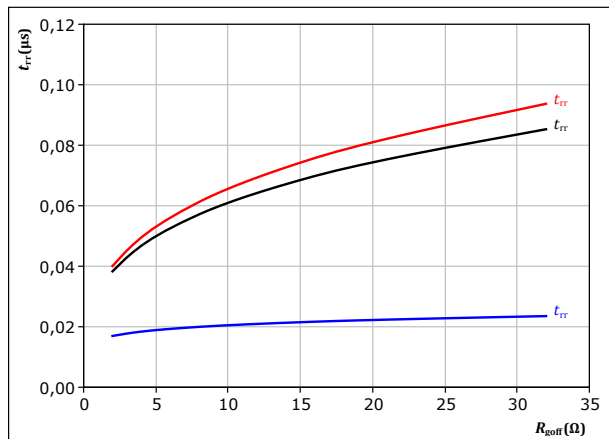
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{g(on)} = 8 \text{ } \Omega$
 $T_j: \text{ — } 25 \text{ }^\circ\text{C}$
 $\text{ — } 125 \text{ }^\circ\text{C}$
 $\text{ — } 150 \text{ }^\circ\text{C}$

figure 41. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{g(off)})$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 30 \text{ A}$
 $T_j: \text{ — } 25 \text{ }^\circ\text{C}$
 $\text{ — } 125 \text{ }^\circ\text{C}$
 $\text{ — } 150 \text{ }^\circ\text{C}$

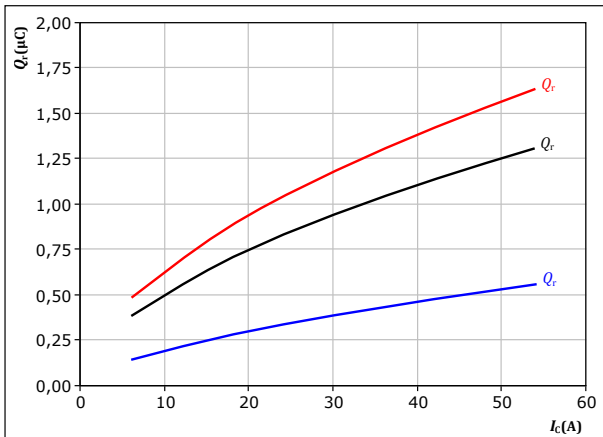


PFC Switching Characteristics

figure 42. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

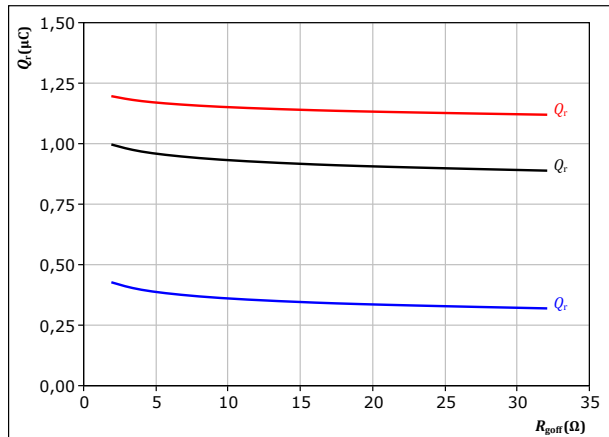
$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 8 \text{ } \Omega$

T_j : $25 \text{ } ^\circ\text{C}$ (blue)
 $125 \text{ } ^\circ\text{C}$ (black)
 $150 \text{ } ^\circ\text{C}$ (red)

figure 43. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

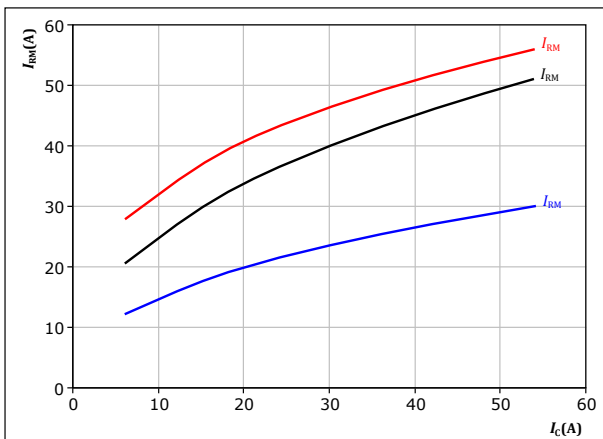
$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 30 \text{ A}$

T_j : $25 \text{ } ^\circ\text{C}$ (blue)
 $125 \text{ } ^\circ\text{C}$ (black)
 $150 \text{ } ^\circ\text{C}$ (red)

figure 44. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

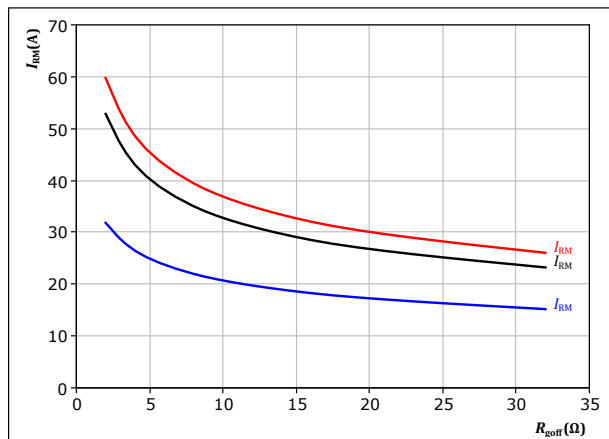
$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 8 \text{ } \Omega$

T_j : $25 \text{ } ^\circ\text{C}$ (blue)
 $125 \text{ } ^\circ\text{C}$ (black)
 $150 \text{ } ^\circ\text{C}$ (red)

figure 45. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 30 \text{ A}$

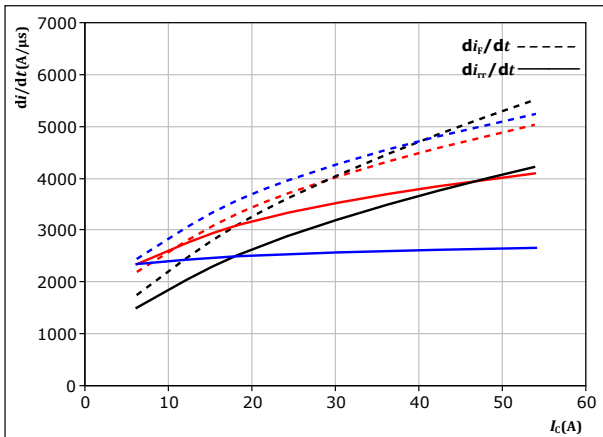
T_j : $25 \text{ } ^\circ\text{C}$ (blue)
 $125 \text{ } ^\circ\text{C}$ (black)
 $150 \text{ } ^\circ\text{C}$ (red)



PFC Switching Characteristics

figure 46. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_c)$

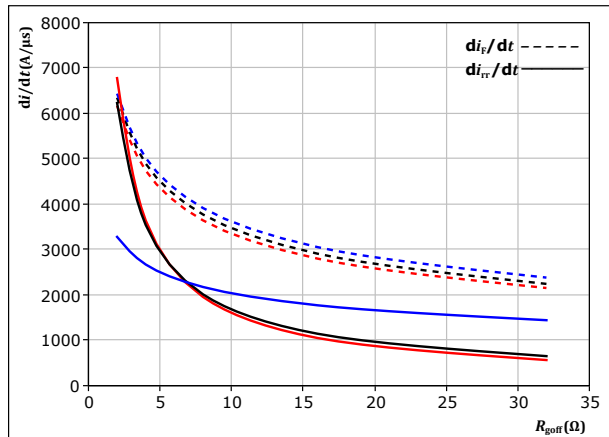


With an inductive load at

$V_{CE} = 400$ V	$T_j = 25$ °C
$V_{GE} = 0/15$ V	$T_j = 125$ °C
$R_{g(on)} = 8$ Ω	$T_j = 150$ °C

figure 47. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{g(off)})$



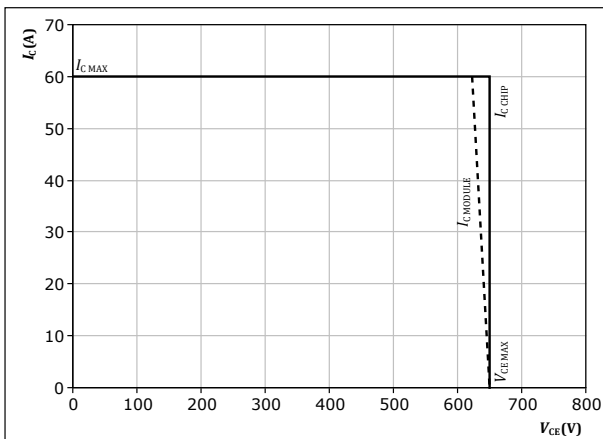
With an inductive load at

$V_{CE} = 400$ V	$T_j = 25$ °C
$V_{GE} = 0/15$ V	$T_j = 125$ °C
$I_c = 30$ A	$T_j = 150$ °C

figure 48. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150$ °C
 $R_{g(on)} = 8$ Ω
 $R_{g(off)} = 8$ Ω



Switching Definitions

figure 49. IGBT
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

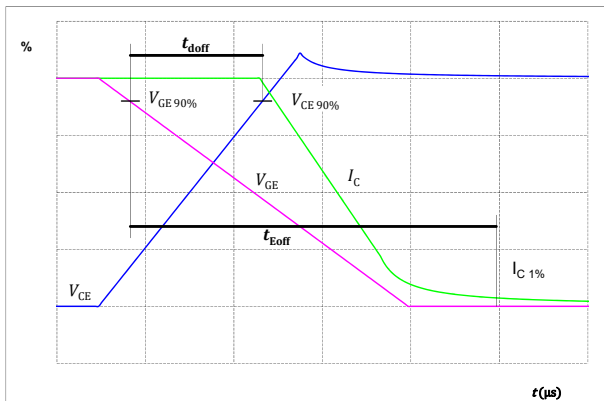


figure 50. IGBT
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

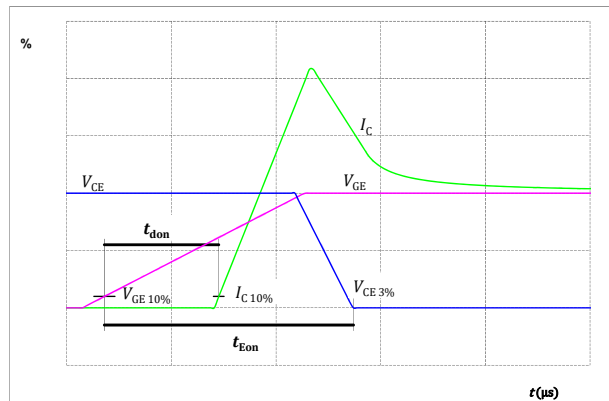


figure 51. IGBT
Turn-off Switching Waveforms & definition of t_f

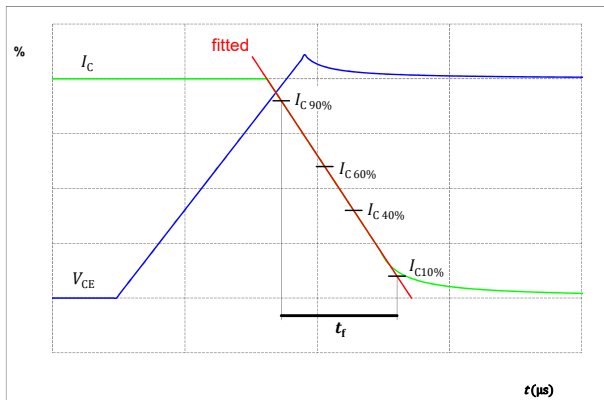
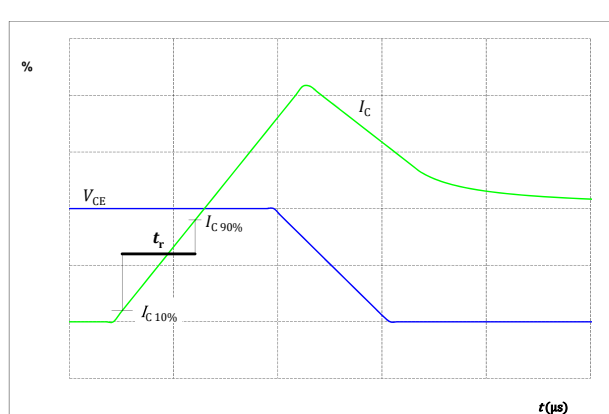


figure 52. IGBT
Turn-on Switching Waveforms & definition of t_r





Switching Definitions

figure 53. FWD

Turn-off Switching Waveforms & definition of t_{rr}

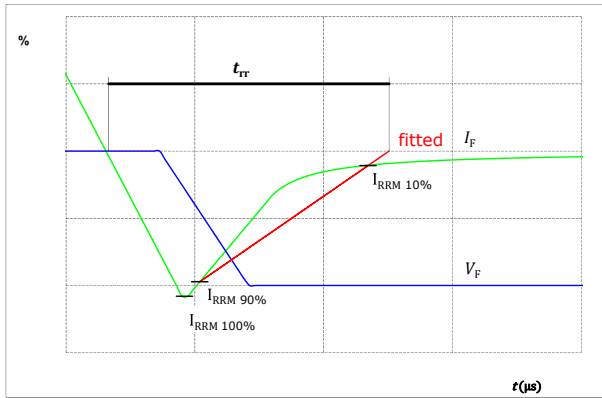
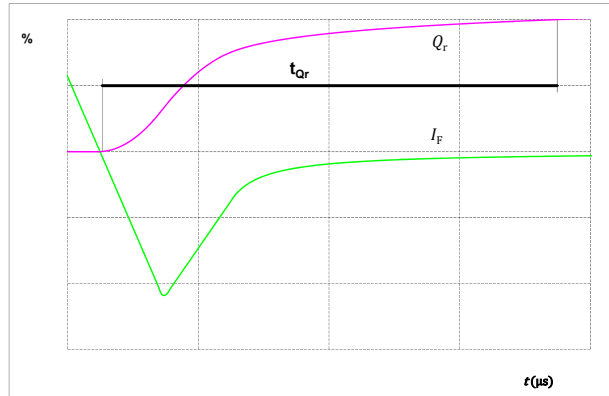


figure 54. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





Ordering Code	
Version	Ordering Code
Without thermal paste	10-PG06PPA050SJ02-LH94E08T
With thermal paste (5,2 W/mK, PTM6000HV)	10-PG06PPA050SJ02-LH94E08T-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-PG06PPA050SJ02-LH94E08T-/3/

Marking						
	Text	Name NN-NNNNNNNNNNNNN- TTTTTVV	Date code WWYY	UL & VIN UL VIN	Lot LLLLL	Serial SSSS
	Datamatrix	Type&Ver TTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY	

Outline			
Pin table [mm]			
Pin	X	Y	Function
1	52,5	2,7	DC+Inv
2	52,5	0	DC+Inv
3	46,2	0	Ph3
4	43,5	0	Ph3
5	43,5	3	G16
6	37,2	0	Ph2
7	34,5	0	Ph2
8	34,5	3	G14
9	28,2	0	Ph1
10	25,5	0	Ph1
11	22,5	0	G12
12	0	0	PFC1
13	0	6,1	PFC2
14	not assembled		
15	not assembled		
16	25,5	8,3	S25
17	25,5	11,3	G25
18	not assembled		
19	not assembled		
20	0	22,5	G29
21	0	25,5	S29
22	0	28,5	PFC-3
23	2,7	28,5	PFC-3
24	9,8	25,8	PFC+
25	9,8	28,5	PFC+
26	20,7	16,5	S27
27	20,7	19,5	G27
28	16,9	23,5	PFC-2
29	16,9	26,5	PFC-2
30	20,7	28,5	PFC-1
31	23,4	28,5	PFC-1
32	22	25,5	Therm1
33	22	22,5	Therm2
34	not assembled		
35	33,5	28,5	DC-1
36	33,5	25,5	DC-1
37	33,5	22,5	G11
38	not assembled		
39	43	28,5	DC-2
40	43	25,5	DC-2
41	43	22,5	G13
42	not assembled		
43	52,5	28,5	DC-3
44	52,5	25,5	DC-3
45	52,5	22,5	G15
46	0	12,2	PFC3

center of pins: 0,05mm
for connection parameter see the handling instruction

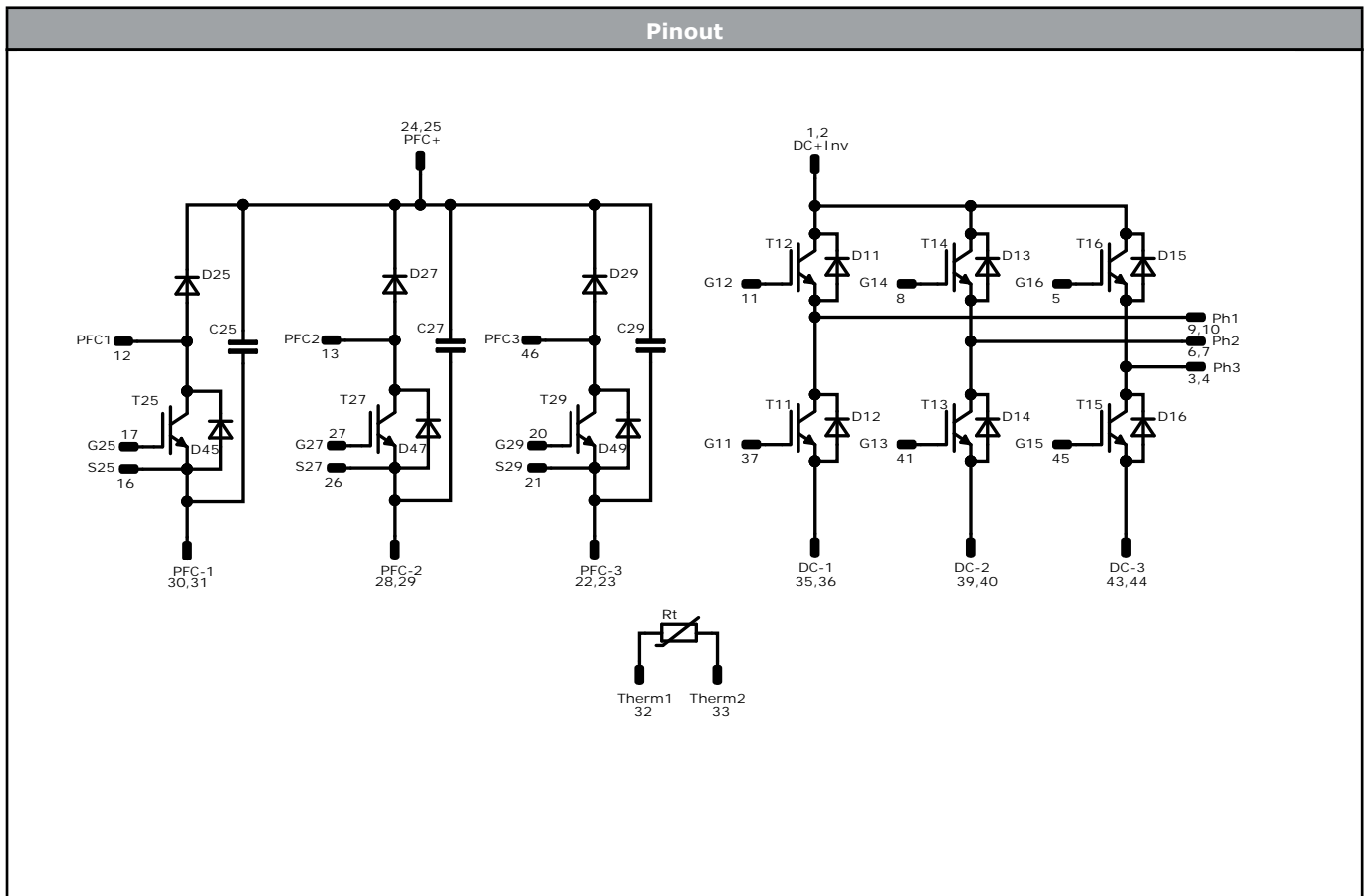
92,2 ± 0,15
3,4 ± 0,5

1,25
28,25

Tolerance of positions: ±0,04mm at the end of pins
Dimension of coordinate axis is only offset without tolerance



Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	600 V	50 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	600 V	30 A	Inverter Diode	
T25, T27, T29	IGBT	650 V	30 A	PFC Switch	
D25, D27, D29	FWD	650 V	30 A	PFC Diode	
D45, D47, D49	FWD	650 V	10 A	PFC Sw. Protection Diode	
C25, C27, C29	Capacitor	630 V		Capacitor (PFC)	
Rt	Thermistor			Thermistor	




Vincotech

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow 1</i> packages see vincotech.com website.

Package data
Package data for <i>flow 1</i> packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-PG06PPA050SJ02-LH94E08T-D3-14	26 Sep. 2021	New Datasheet format, module is unchanged Update Rth of Inverter Switch	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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